



Carrier lifetime variations during irradiation by 3 - 8 MeV protons @ 40-300 K in MCZ Si

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Outline

- HUAL & VU instrumentation for lifetime measurement during proton irradiation, in-situ positioning and control
- Lifetime-temperature characteristics for initial MCz material and during irradiation with stopped and penetrative protons at different temperatures
- Summary





Motivavtion



It is interesting to understand:

if this linear dependence is a result of irradiation

it is a consequence of irradiation and migration of defects to form other type of defects



The microwave probed photoconductivity (MW-PC) modules for the direct measurements of the carrier decay transients by employing MW absorption are assembled. VUTEG-3HE, master PC-NB, antenna/excitation fiber modules, positioning and visual control modules are installed within irradiation chamber containing a cold finger for cooling of a sample by using closed-cycle He cryostat. Delivering of signals to destination outside running irradiation area are implemented by using LAN.



Assembled instrumentation for τ -exposure-T measurements





3D positioning & inputs

MW needle-

tip antenna

and fiber

probes

Drivers & and remote control instrumentation



Distant transfer lines



Beyond-radiation area & Measurement and operating instrumentation



Sample side for cross-sectional scan



τ -T measurements after irradiations





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Thermo-couple



τ-exposure at various T characteristics during irradiation with penetrative protons probes are located at half-width of wafer thickness



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Irradiation of pre-irradiated Si





τ -T results for initial material before irradiation





Two-componential decay in the initial MCZ material wafers, ascribed to carrier recombination (τ_R) and trapping (τ_{ttr}), is observed, and these decay constituents show different temperature characteristics.

For trapping constituent, a few peaks was be observed.



$\tau\text{-}\text{T}$ characteristics in the 8 MeV proton post-irradiated material

Several carrier trapping components appear in τ -T characteristics after irradiation. Si 8MeV protons irradiated at T= 280K

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$\tau\text{-exposure}$ dependence during implantation of 3 MeV protons

Microwave probe and optical fiber are located at ~ 80 μm distance from the irradiation (beam side) face-surface of wafer







Summary

- The dependence of lifetime on fluence during irradiation by protons shows a dependence of defects generation rate on the temperature and of irradiation, i.e., irradiation itself induces the defect reactions in the sample.
- The pre-irradiation also creates the different conditions for defect reactions.

(The increase of statistics is necessary)

- Two-componential decay in the initial MCZ material wafers, ascribed to carrier recombination (τ_R) and trapping (τ_{ttr}), is observed, and these decay constituents show different temperature characteristics.
- Several carrier trapping components appear in τ -T characteristics after irradiation by penetrative protons.





Thank You for attention!

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